

苏州杭晶电子科技有限公司

产品规格书 Product Specification

| CUSTOMER | 客户: | |
|-------------------|---------|-----------------------------------|
| CUSTOMER PN | 客户 PN: | |
| | | |
| HANG CRYSTAL P/N | 杭晶物料编码: | TC53S4-14.7456-28MLDTNG |
| MODEL | 产品型号: | TCXO SMD 5.0x3.2, Sine wave, 2.8V |
| NOMINAL FREQUENCY | 频率: | 14.7456MHz |
| | | |
| ISSUE DATE | 日期: | 2022 / 09 / 14 |

CUSTOMER'S APPROVAL 客户确认

APPROVED QA

MB

Qiang

(PLEASE RETURN A COPY WITH APPOVAL) (请将确认的复印件返回我司) SUZHOU HANGJING ELEC&TECH CO.,LTD 苏州杭晶电子科技有限公司 No. 207, Blk. B, Chenlei Science & Technology Park, No. 1, First Qunxing Road, Suzhou Industrial Park, Jiangsu, China TEL 86 (0)512 65916689 FAX 86 (0)512 65918005

| Revision | Description / ECN | Prepared | Approved | Date |
|----------|-------------------|----------|-------------|------------|
| 1 | Initial release | MB | James Jiang | 2022-09-14 |
| 2 | Not issued | | | |
| 3 | Not issued | | | |
| 4 | Not issued | | | |

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1. NOMINAL AND MAXIMUM RATINGS, OPERATING AND STORAGE CONDITIONS

| | PARAMETER | SYMB. | MIN | TYP | MAX | Unit | Conditions / Remarks |
|---|--------------------------------|------------------|-------------|-----------|-------|-----------------|--------------------------|
| 1 | Nominal frequency | F _N | 1 | 4.7456 | i | MHz | |
| 2 | Maximum supply voltage | V _{MAX} | -0.3 | | +5.25 | V _{DC} | Between Vcc and GND |
| 3 | Operating supply voltage range | Vcc | 2.66 | 2.8 | 2.94 | V _{DC} | Note 1 |
| 4 | Output load resistance | RL | 9 | 10 | 11 | kΩ | Clipped sine wave output |
| 5 | Output load capacitance | CL | 9 | 10 | 11 | pF | Clipped sine wave output |
| 6 | Operating temperature range | T _{OP} | -40 | +25 | +85 | °C | Note 1 |
| 7 | Storage Temperature Range | T _{ST} | - 55 | | 105 | °C | |
| 8 | Enable / Disable function | E/D | No | t availal | ole | | Pin 1 N.C. |

Note 1: over the whole range, the unit stays within all relevant parameter limits as specified under point 2.

2. ELECTRICAL PARAMETER LIMITS

| | PARAMETER | SYMB. | MIN | TYP | MAX | Unit | Conditions / Remarks |
|----|--|--------------------|------|------|-------|------------------|--|
| 1 | Frequency calibration | ∆f/F _N | -1.5 | | +1.5 | ppm | Offset from nominal at +25°C |
| 2 | Frequency stability over T _{OP} | ∆f/F _{OP} | -2.0 | | +2.0 | ppm | Over T _{OP} Note 1 |
| 4 | Frequency VS voltage changes | ∆f/F∨ | -0.2 | | +0.2 | ppm | Vcc ±5% at +25°C |
| 4 | Frequency VS load changes | ∆f/F∟ | -0.2 | | +0.2 | ppm | RL//CL ±10% at +25°C |
| 5 | Aging first year | Δf/F _{A1} | -1.0 | | +1.0 | ppm | at +25°C |
| 6 | Output amplitude voltage level | V _{P-P} | 0.8 | | | V _A C | Clipped sine wave |
| 7 | Output symmetry (Duty Cycle) | DC | 45 | | 55 | % | GND level (DC cut) |
| 8 | Harmonics | H ₃ | | | -10.0 | dBc | 3 rd harmonics |
| 9 | Phase noise | L _{RMS} | | -87 | | dBc/Hz | at 10Hz offset / at +25°C |
| | | | | -114 | | | at 100Hz offset / at +25°C |
| | | | | -133 | | | at 1kHz offset / at +25°C |
| | | | | -148 | | | at 10kHz offset / at +25°C |
| | | | | -150 | | | at 100kHz offset / at +25°C |
| 10 | Startup time | t _{STRT} | | | 2.0 | ms | V _{P-P} reach >90% of amplitude |
| | | | | | 2.0 | ms | Note 2 |
| 11 | Current consumption | Icc | | | 2.0 | mA | Under load RL//CL ±10% |

Note 1: Referenced to midpoint between minimum and maximum frequency over specified temperature range.

Note 2: Until frequency is within $\pm 0.5 ppm$ in reference to nominal frequency.

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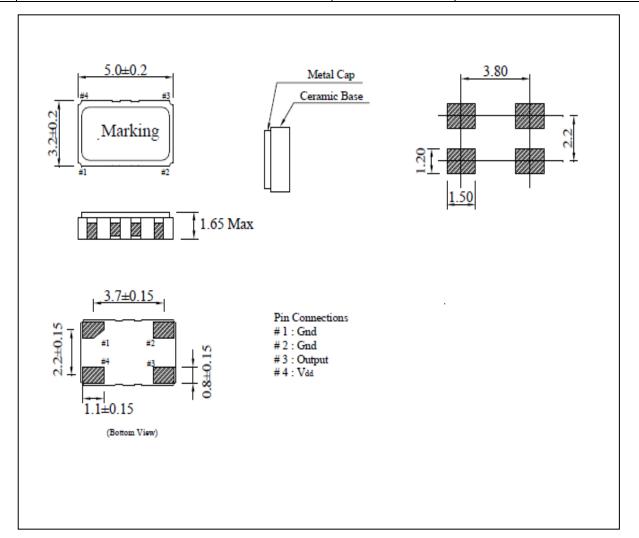
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3. PRODUCT MARKING

To be defined.

4. OUTLINE DRAWING

| Package description | Package model | Remarks |
|--|----------------|---------|
| Ceramic seam seal SMD package5.0x3.2mm with 4 pads | CST5032p4cph16 | |



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5. RELIABILITY TEST INFORMATION

| | Test item | Test conditions | Criteria |
|----|---------------------------------|--|-------------|
| 1 | High temperature storage | Temperature: +125°C ±5°C Time: 240 ±4 Hours Tested after 4 to 12h at room temperature. | ±1.0ppm |
| 2 | Low temperature storage | Temperature: -55°C ±5°C Time: 240 ±4 Hours Tested after 4 to 12h at room temperature. | ±1.0ppm |
| 3 | Temperature humidity bias THB | Temperature: +85°C ±5°C Humidity: 85% ±5% RH Time: 240 ±4 Hours BIAS: Supply Voltage Tested after 4 to 12h at room temperature. | ±1.0ppm |
| 4 | Temperature cycling | Low Temp. cycle: -55°C ±2°C High Temp. cycle: +85°C ±5°C Time: 30min each cycle Number of cycles: 1,000 Tested after 4 to 12h at room temperature. | ±1.0ppm |
| 5 | Aging | Temperature: +85°C ±5°C Time: 30d Tested after 4 to 12h at room temperature. | ±1.0ppm |
| 6 | Resistance to solder heat | Reflow peak temp.: +260°C ±5°C (refer to rec. profile) Number of cycles: 3 times Tested after 4 to 12h at room temperature. | ±1.0ppm |
| 7 | Solderability (MIL-STD-883E) | Dip in flux: 5~10 Seconds Temperature: 230°C ±10°C Time: 5 Seconds Tested after 4 to 12h at room temperature. | >95% cover. |
| 8 | Drop test | Drop height: 120cm Number of cycles: 12 times Drop height: 150cm Number of cycles: 9 times With jig (120~150g) onto iron plate Tested after 24h at room temperature. | ±1.0ppm |
| 9 | Vibration | Frequency Range: 20~2000Hz PSD: 0.053g² Time: 40min each direction (X,Y,Z) Tested after 4 to 12h at room temperature. | ±1.0ppm |
| 10 | ESD-HBM | HBM, V=±1KV, C=100pF, R1=10M, R2=1.5K, 3times | ±1.0ppm |

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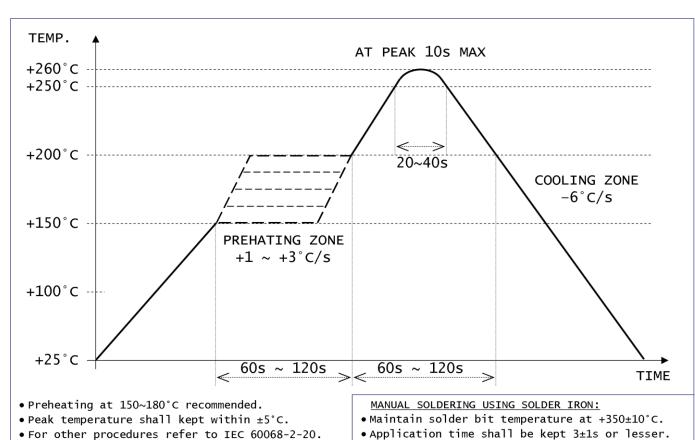
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6. ENVIRONMENTAL COMPLIANCE INFORMATION

| | | Compliance information |
|---|---|---|
| 1 | RoHS | This product is fully RoHS compliant, 6/6 compliant per EU legislation. |
| 2 | RoHS 2 | In regards of RoHS 2, CE marking directive for finished products, we can provide RoHS test reports and MDS to show compliance, but since our product is not a final application we have no CE mark. |
| 3 | Lead-Free | This product is considered Lead-Free, Lead (Pb) contamination is controlled to be below 200ppm. |
| 4 | Halogen-Free | This product is compliant to IEC 61249-2-21:2003 (Br<800ppm / Cl<800ppm). |
| 5 | REACH (SVHC) | This product does not contain substances (SVHC) listed by REACH, we continuously monitor updates of the list of SVHC's |
| 6 | PFOS / PFOA Free | This product is free of any PFOS / PFOA. |
| 7 | Electrostatic Discharge (ESD) sensitivity | This product is ESD sensitive and requires precautions for handling and storage. Follow JEITA EIAJ ED-4701 or JSD22 or ANSI-ESD-S20-20 or IEC 61000-4-2. |
| 8 | Moisture Sensitivity | This product is hermetically sealed and does NOT fall under the classification of moisture sensitivity per J-STD-020C (Standard is for non-hermetically sealed components). If required we suggest to use LEVEL 1 |

7. RECOMMENDED SOLDERING INFORMATION

RECOMMENDED REFLOW SOLDER PROFILE - PEAK TEMPERATURE UP TO +260°C



DWG_ReflowProfile_260

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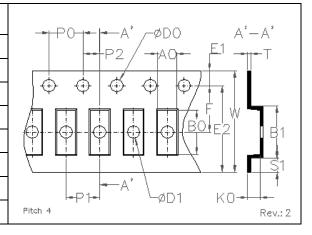


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8. PACKAGING

<u>Carrier</u>

| | Parameter | STANDARD PACKAGING | ALTERNATE PACKAGING |
|---|-----------|-----------------------|------------------------|
| 1 | A0 | 3.6±0.1 | |
| 2 | В0 | 5.4±0.1 | |
| 3 | K0 | 1.6±0.1 | |
| 4 | B1 | 6.0±0.1 | |
| 5 | P0 | 4.0±0.1 | |
| 6 | P1 | 8.0±0.1 | |
| 7 | Т | 0.3±0.05 | |
| 8 | W | 12.0±0.2 | |



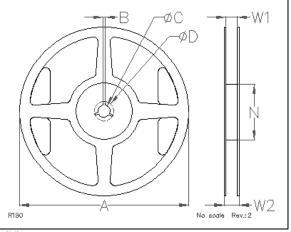
Note 1: All dimensions in [mm].

Note 2: All dimensions not specified or not being shown follow EIA-481 standard.

<u>Reel</u>

QTY per reel: 1,000pcs MAX

| | Parameter | STANDARD PACKAGING | ALTERNATE PACKAGING |
|----|-----------|---------------------------|------------------------|
| 9 | А | 178 ⁺⁰ -1.5 | |
| 10 | В | 2.0±0.5 | |
| 11 | ØС | 13.2±0.2 | |
| 12 | ØD | 21±0.8 | |
| 13 | N | 62±2.0 | |
| 14 | W1 | 12.4 ^{+2.0} | |
| 15 | W2 | 16.4 +2.0 -0 | |



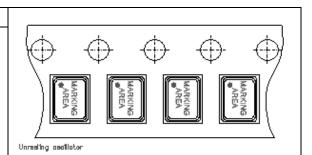
Note 1: All dimensions in [mm]. Dimension W1 is measured near the Hub (N).

Note 2: All dimensions not specified or not being shown follow EIA-481 standard.

Unreeling information

Oscillator product's orientation

This product is a polarized component which requires a certain orientation; Pin 1 is identified on top side marking with a DOT. In the carrier tape is the component oriented with pin 1 towards the sprocket holes. (per EIA-481)



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